

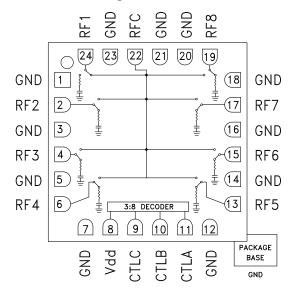


Typical Applications

The HMC253ALC4 is ideal for:

- Basestations & Repeaters
- WiMAX/WiBro & Fixed Wireless
- Cellular/3G Infrastructure
- CATV/DBS
- Military & Hi-Rel

Functional Diagram



Features

Ceramic, RoHS Compliant 4x4 mm SMT Package

Non-Reflective Topology Low Insertion Loss: 1.6 dB

Single Positive Supply: Vdd = +5V

Integrated 3:8 TTL/CMOS Decoder: 0/+3V

General Description

The HMC253ALC4 is a non-reflective SP8T switch in a leadless RoHS compliant 4x4 mm ceramic SMT package featuring wideband operation from DC to 3.5 GHz. The switch offers a single positive bias and true TTL/CMOS compatibility enabling it to operate with 0/+3V control and a +5V supply. A 3:8 decoder is integrated on the switch requiring only 3 control lines and a positive bias to select each path. The HMC253ALC4 SP8T will replace multiple configurations of SP4T and SPDT MMIC switches.

Electrical Specifications,

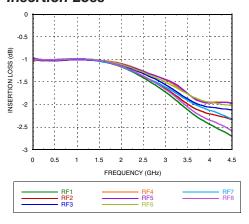
 $T_{A} = +25^{\circ}$ C, For TTL Control and Vdd = +5V in a 50 Ohm system

Parameter		Frequency	Min.	Тур.	Max.	Units
Insertion Loss		DC - 2.0 GHz DC - 3.0 GHz DC - 3.5 GHz		1.1 1.6 1.9	1.5 2.0 2.4	dB dB dB
Isolation		DC - 2.0 GHz DC - 3.0 GHz DC - 3.5 GHz	38 34 30	43 39 35		dB dB dB
Return Loss	"On State"	0.3 - 3.0 GHz 0.3 - 3.5 GHz		13 10		dB dB
Return Loss (RF1-8)	"Off State"	0.3 - 3.5 GHz 0.5 - 3.5 GHz		10 14		dB dB
Input Power for 1 dB Compression		0.5 - 3.5 GHz	20	24		dBm
Input Third Order Intercept (Two-Tone Input Power = +10 dBm Each Tone)		0.5 - 3.5 GHz	40	43		dBm
Switching Characteristics		0.3 - 3.5 GHz				
tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF)				30 100		ns ns

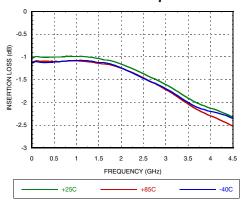




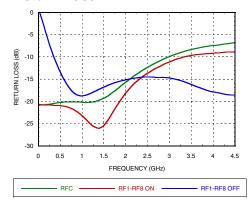
Insertion Loss



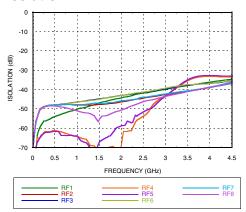
Insertion Loss vs. Temperature



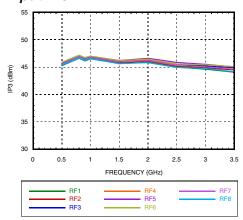
Return Loss



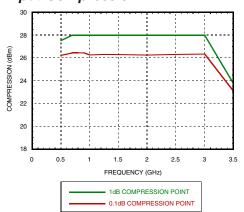
Isolation



Input IP3



Input Compression







Bias Voltage & Current

Vdd Range = +5 Vdc ± 10%			
Vdd (Vdc)	Idd (Typ.) (mA)	Idd (Max.) (mA)	
+5	4.5	7.5	

TTL/CMOS Control Voltages

State	Bias Condition	
Low	0 to +0.8 Vdc @ <1 μA Typ.	
High	+2.0 to +5 Vdc @ 60 μA Typ.	

Truth Table

Control Input			Signal Path State	
Α	В	С	RFCOM to:	
Low	Low	Low	RF1	
High	Low	Low	RF2	
Low	High	Low	RF3	
High	High	Low	RF4	
Low	Low	High	RF5	
High	Low	High	RF6	
Low	High	High	RF7	
High	High	High	RF8	

NOTE.

DC Blocking capacitors are required at ports RFC and RF1, 2, 3, 4, 5, 6, 7, 8.



Absolute Maximum Ratings

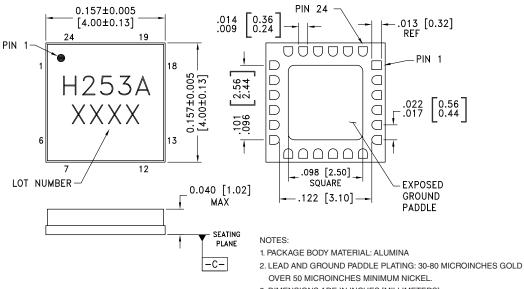
Bias Voltage Range (Port Vdd)	+7.0 Vdc
Control Voltage Range (A, B, C)	-0.5V to Vdd +1Vdc
Channel Temperature	150 °C
Thermal Resistance (channel to package ground paddle)	
Through Path	183 °C/W
Termination Path	274 °C/W
Terrimation ratir	274 0/ **
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
Maximum Input Power (Vdd = +5V)	
Through Path	+20 dBm (0.05 - 0.5 GHz)
11110491114411	+25 dBm (0.5 - 3.5 GHz)
Terminated Path	+20 dBm (0.05 - 0.5 GHz)
Terminated Patri	, ,
	+23.5 dBm (0.5 - 3.5 GHz)
ESD Sensitivity (HBM)	Class 1A





Outline Drawing

BOTTOM VIEW



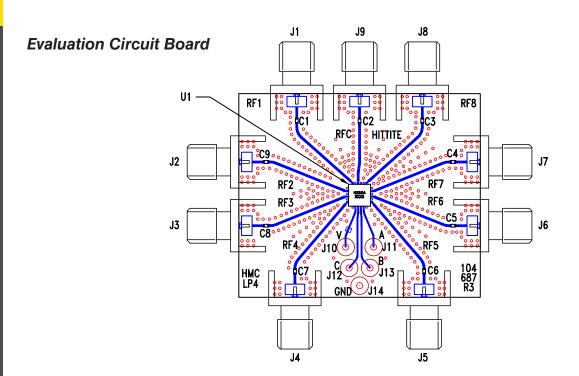
- 3. DIMENSIONS ARE IN INCHES [MILLIMETERS].
- 4. LEAD SPACING TOLERANCE IS NON-CUMULATIVE.
- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm DATUM -C-
- $6.\,\mathrm{ALL}$ GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1, 3, 5, 7, 12, 14, 16, 18, 20, 21, 23	GND	Package bottom has exposed metal paddle that must also be connected to RF ground.	O CND
2, 4, 6, 13, 15, 17, 19, 22, 24	RF1 - RF8 & RFC	This pin is DC coupled and matched to 50 Ohms. Blocking capacitors are required.	
8	Vdd	Supply Voltage +5 Vdc ±10%	Vdd 0
9	CTLC		Vdd
10	CTLB	See truth table and control voltage table.	<u> </u>
11	CTLA		<u> </u>







List of Materials for Evaluation PCB EV1HMC253ALC4 [1]

Item	Description	
J1 - J9	PCB Mount SMA Connector	
J10 - J14	DC Pin	
C1 - C9	100 pF Capacitor, 0402 Pkg.	
U1	HMC253ALC4 SP8T Switch	
PCB [2]	104687 Eval Board	

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

The circuit board used in the application should be generated with proper RF circuit design techniques. Signal lines at the RF ports should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown above. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown above is available from Hittite Microwave Corporation upon request.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Switch ICs category:

Click to view products by Analog Devices manufacturer:

Other Similar products are found below:

MASW-007921-002SMB BGSA142GN12E6327XTSA1 BGSA142MN12E6327XTSA1 BGSA142M2N12E6327XTSA1 MASW-00410011930W MASW-008853-TR3000 BGS13SN8E6327XTSA1 BGSF18DM20E6327XUMA1 BGSX210MA18E6327XTSA1

BGSX212MA18E6327XTSA1 SKY13446-374LF SW-227-PIN PE42524A-X CG2185X2 CG2415M6 MA4AGSW1A MA4AGSW2

MA4AGSW3 MA4AGSW5 MA4SW210B-1 MA4SW410 MASW-002102-13580G BGS 12PL6 E6327 BGS1414MN20E6327XTSA1

BGSS1515MN20E6327XTSA1 BGSA11GN10E6327XTSA1 BGSX28MA18E6327XTSA1 HMC199AMS8 HMC595AETR HMC986A

SKY13374-397LF SKY13453-385LF CG2430X1-C2 TGS4304 UPG2162T5N-A CG2415M6-C2 AS222-92LF SW-314-PIN

UPG2162T5N-E2-A BGS18GA14E6327XTSA1 MASWSS0204TR-3000 MASWSS0201TR MASWSS0181TR-3000 MASW-007588
TR3000 MASW-007075-000100 MASW-004103-13655P MASW-003102-13590G MASWSS0202TR-3000 MASW-008543-TR3000

MA4SW310B-1